



REGISTRATION FORM

31ST ASEAN+3 BOND MARKET FORUM (ABMF) MEETING DAITO BUNKA UNIVERSITY, TOKYO, JAPAN 24-28 JUNE 2019

PLEASE RETURN THE COMPLETED FORM BY EMAIL ON OR BEFORE **24 MAY 2019** TO MS. SHEILA SOMBILLO (ssombillo.consultant@adb.org)

INSTRUCTIONS: (1) PLEASE PROVIDE COMPLETE DETAILS; (2) PRINT LEGIBLY; (3) MARK THE APPROPRIATE BOX

GENERAL INFORMATION

MR. MS. DR. OTHERS _____

FIRST NAME*

LAST NAME*

COUNTRY*

ORGANIZATION/INSTITUTION*

DESIGNATION/POSITION*

DEPARTMENT/DIVISION*

EMAIL*

TELEPHONE NUMBER*

FAX NO.:

DIETARY REQUIREMENT(S)

STAYING AT METROPOLITAN YES

HOTEL IKEBUKURO/PRINCE NO (If NO, kindly provide hotel name & address below)

HOTEL * Hotel name & Address:

NEED VISA ASSISTANCE YES (If yes, please fill out Visa Info Sheet)

(SUPPORTING DOCUMENTS)* NO

EVENTS ATTENDANCE:

DATE	PARTICULARS	ATTENDANCE* (Please mark appropriate box)
24 June 2019	➤ DAY 1: ABMF Sub Forum 1 Meeting Time: 09:00AM – 4:30PM	<input type="checkbox"/> Will Attend <input type="checkbox"/> Unable to Attend
25 June 2019	➤ DAY 2: Sub Forum 2 Meeting Time: 9:00AM – 4:30PM	<input type="checkbox"/> Will Attend <input type="checkbox"/> Unable to Attend
26 June 2019	➤ DAY 3: ABMF-XBRL Joint Asian Rountable - Part 1 Time: 9:00AM – 5:00PM	<input type="checkbox"/> Will Attend <input type="checkbox"/> Unable to Attend
	➤ Welcome Reception Venue: TBC Time: TBC	<input type="checkbox"/> Will Attend <input type="checkbox"/> Unable to Attend
27 June 2019	➤ DAY 4: ABMF-XBRL Joint Asian Rountable - Part 2 Time: 9:00AM – 3:00PM	<input type="checkbox"/> Will Attend <input type="checkbox"/> Unable to Attend
28 June 2019	➤ DAY 5: Future of Technology Day Site Visit: NTTDATA Time: TBC	<input type="checkbox"/> Will Attend <input type="checkbox"/> Unable to Attend

Please complete additional form for each attendee.